ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				Materials and	ials and Mfg Information				
upplier Inform	ation													
Company name*			Company unique ID			1	Unique ID Authority				Response Date*			
onsemi											2024-05-08			
Contact Name			Title - Contact			1	Phone - Contact*				Email - Contact*			
Product-Env-Stewar	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
uthorized Represer	ntative*		Title - Representative			1	Phone - Representative*				Email - Representative*			
Product-Env-Stewar	ırds		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester	er Item Number	em Number Mfr Item Number Mfr Item		Mfr Item Name			Effective Date	Version	Manufacturing S	ite	Weight*	UOM	Unit Type	
				5.1V 5% 1 W Zen	1V 5% 1 W Zener		2024-05-08 CN2			324.186	mg	Each		
	Process Informati		arminal Rasa	Alloy	-STD-020 MSI	I. Poting	Pank Proc	oss Rody Tam	paratura May Time at	Dagk Tampa	aratura Numb	or of Paflow Cv	clas	
						L Kanng		Peak Process Body Temperature Max Time at Peak O C 30						
	ii (Dii) uiiiteitei		Cinoy	1	11.8				150	300	7011db 5			
Comments														
Matte Tin	Plating / Grid Array Mate n (Sn) - annealed on regarding material c	C	CU Alloy please refer to	N		L Kating						er of Keflow (

RoHS Material Composition Declaration			Declaration 7	Гуре *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Isability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absen											
RoHS Declaration * 4 - Item(s	does not contain RoHS restricted substances	per the definition above except for sele	ted exemptions	Supplier Acceptance	* Accepted						
Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	E_									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
CSS Wire	202.316	mg	Supplier	Sulfur (S)	7704-34-9		0.1012	mg
			Supplier	Carbon (C)	7440-44-0		1.0116	mg
			Supplier	Manganese (Mn)	7439-96-5		0.4046	mg
			Supplier	Iron (Fe)	7439-89-6		129.988	mg
			Supplier	Copper (Cu)	7440-50-8		70.7094	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1012	mg
Die	0.093	mg	Supplier	Silicon (Si)	7440-21-3		0.093	mg
Dumet Wire	57.927	mg	Supplier	Manganese (Mn)	7439-96-5		0.5213	mg
			Supplier	Silicon (Si)	7440-21-3		0.2317	mg
			В	Nickel (Ni)	7440-02-0		18.3339	mg
			Supplier	Iron (Fe)	7439-89-6		25.2851	mg
			Supplier	Copper (Cu)	7440-50-8		13.5549	mg
Glass Encapsulation	60.33	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		1.8099	mg
			A	Lead Oxide (PbO)	1317-36-8	7c	36.922	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.0302	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		2.2624	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		19.3056	mg
Plating	3.52	mg	Supplier	Tin (Sn)	7440-31-5		3.52	mg